

Amendments to the Claims

1. **(Previously Amended)** A method of producing synthetic resin film for laminates, said synthetic resin film comprising a substrate impregnated with a thermosetting resin, said method comprising
 - (a) impregnating the substrate with a first thermosetting resin composition comprising a first uncured thermosetting resin and a low profile additive,
 - (b) drying the impregnated substrate of (a),
 - (c) impregnating the substrate of (b) with a second thermosetting resin composition comprising a second uncured thermosetting resin and a low profile additive, and
 - (d) drying the impregnated substrate of (c).
2. **(Previously Amended)** The method of claim 39, further comprising at least partially curing the first uncured thermosetting resin in the impregnated substrate.
3. **(Previously Amended)** The method of claim 39, wherein said low profile additive comprises ceramic microspheres.
4. **(Previously Amended)** The method of claim 39, wherein said low profile additive comprises thermoplastic polymer powder.
5. **(Previously Amended)** The method of claim 39, wherein said low profile additive comprises polyethylene powder.
6. **(Previously Amended)** The method of claim 39, wherein said first and second uncured thermosetting resin are each selected from the group consisting of melamine-formaldehyde, urea-formaldehyde, phenol-formaldehyde and mixtures thereof.
7. **(Previously Amended)** The method of claim 39, wherein the substrate is paper.

8. **(Currently Amend d)** The method of claim 39, wherein the low profile additive is present in amounts sufficient to provide said synthetic resin film with a scratch resistance of ~~at least~~ about 2.5 Newtons or higher.

9. Synthetic resin film for laminates produced by the method according to claim 1.

10. **Previously Cancelled.**

11. **(Previously Amended)** The method of claim 1, further comprising at least partially curing the second uncured thermosetting resin in the impregnated substrate.

12. **(Previously Amended)** The method of claim 1, wherein said first uncured thermosetting resin and said second uncured thermosetting resin are the same.

13 - 15. **Previously Cancelled.**

16. **(Previously Amended)** The method of claim 1, wherein said first uncured thermosetting resin and said second uncured thermosetting resin are independently selected from the group consisting of melamine-formaldehyde, urea-formaldehyde, phenol formaldehyde and mixtures thereof.

17 - 25. **Previously Cancelled.**

26. **(Currently Amended)** Synthetic resin film ~~of claim 20~~ for laminates comprising a substrate impregnated with an at least partially cured thermosetting resin and ceramic microspheres, wherein the ceramic microspheres are present in amounts sufficient to provide said synthetic resin film with a scratch resistance of ~~at least~~ about 2.5 Newtons or higher.

27. **(Previously Amended)** A process of producing laminate, said process comprising assembling a plurality of layers of synthetic resin film at least one of said layers being the synthetic resin film of claim 9, and subjecting said assembly to heat and pressure sufficient to effect consolidation of said layers to produce a laminate.

28. **(Previously Amended)** The process of claim 27, wherein the heat necessary to effect consolidation is 230 to 340 degrees F and the pressure necessary to effect consolidation is 800 to 1600 psi.

29. **(Previously Amended)** The laminate produced by the process of claim 27.

30 - 32. **Previously Cancelled.**

33. **(Previously Amended)** A laminate comprising a synthetic resin film of claim 9 laminated to a base material.

34. **(Previously Amended)** The laminate of claim 33, wherein said base material comprises wood.

35. **(Previously Amended)** The laminate of claim 33, wherein said base material is selected from the group consisting of particle board, medium density fiber board and composite panel.

36 - 38. **Previously Cancelled.**

39. **(Previously Added)** The method of claim 1, wherein the low profile additive is inert, substantially spherical and has a particle size in the range of about 5 to about 60 microns.

40 - 44. **Previously Cancelled.**

45. **(Currently Amended)** ~~The A~~ method of claim 40 of producing synthetic resin film for laminates, said synthetic resin film comprising a substrate impregnated with a thermosetting resin, said method comprising

(a) impregnating the substrate with a thermosetting resin composition comprising an uncured thermosetting resin and ceramic microspheres; and

(b) drying the impregnated substrate of (a),

wherein the ceramic microspheres are present in amounts sufficient to provide said synthetic resin film with a scratch resistance of ~~at least~~ about 2.5 Newtons or higher.

46. **(Previously Added)** The method of claim 40 ~~45~~, further comprising (c) impregnating the substrate of (b) with a second thermosetting resin composition comprising a second uncured thermosetting resin and a low profile additive, and (d) drying the impregnated substrate of (c).

47. **Previously Cancelled.**

48. **(Previously Added)** A method of producing synthetic resin film for laminates, said synthetic resin film comprising a substrate impregnated with a thermosetting resin, said method comprising

(a) impregnating the substrate with a thermosetting resin composition comprising an uncured thermosetting resin and ceramic microspheres; and

(b) drying the impregnated substrate of (a), the ceramic microspheres comprising about 0.5 to about 4.75% of the thermosetting resin after drying the impregnated substrate.

49. **(Previously Added)** The method of claim 48, further comprising at least partially curing the uncured thermosetting resin in the impregnated substrate.

50. **(Previously Added)** The method of claim 48, wherein said uncured thermosetting resin is selected from the group consisting of melamine-formaldehyde, urea-formaldehyde, phenol-formaldehyde and mixtures thereof.

51. **(Previously Added)** The method of claim 48, wherein the substrate is paper.
52. **(Currently Amended)** The method of claim 48, wherein the ceramic microspheres are present in amounts sufficient to provide said synthetic resin film with a scratch resistance of ~~at least~~ about 2.5 Newtons or higher.
53. **(Previously Added)** The method of claim 48, further comprising (c) impregnating the substrate of (b) with a second thermosetting resin composition comprising a second uncured thermosetting resin and a low profile additive, and
(d) drying the impregnated substrate of (c).
54. **(Previously Added)** Synthetic resin film for laminates produced by the method according to claim 48.
55. **(Previously Added)** A method of producing synthetic resin film for laminates, said synthetic resin film comprising a substrate impregnated with a thermosetting resin, said method comprising
(a) impregnating the substrate with a thermosetting resin composition comprising an uncured thermosetting resin and alkali alumino silicate ceramic microspheres; and
(b) drying the impregnated substrate of (a).
56. **(Previously Added)** The method of claim 55, further comprising at least partially curing the uncured thermosetting resin in the impregnated substrate.
57. **(Previously Added)** The method of claim 55, wherein said uncured thermosetting resin is selected from the group consisting of melamine-formaldehyde, urea-formaldehyde, phenol-formaldehyde and mixtures thereof.
58. **(Previously Added)** The method of claim 55, wherein the substrate is paper.

59. **(Currently Amended)** The method of claim 55, wherein the alkali alumino silicate ceramic microspheres are present in amounts sufficient to provide said synthetic resin film with a scratch resistance of ~~at least~~ about 2.5 Newtons or higher.

60. **(Previously Added)** The method of claim 55, further comprising (c) impregnating the substrate of (b) with a second thermosetting resin composition comprising a second uncured thermosetting resin and a low profile additive, and
(d) drying the impregnated substrate of (c).

61. **(Previously Added)** Synthetic resin film for laminates produced by the method according to claim 55.